



Customer Information Notification

2018110271

Issue Date: 22-Dec-2018
Effective Date: 22-Jan-2019

Here's your personalized quality information concerning products Digi-Key purchased from NXP.
For detailed information we invite you to view this notification online

This notice is NXP Company Proprietary.



QUALITY

Change Category

- | | | | | |
|--|---|--|---|---|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input checked="" type="checkbox"/> Test Location | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test Process | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Electrical spec./Test coverage |
| <input type="checkbox"/> Firmware | <input type="checkbox"/> Other | | | |

MPC5748G 256MAPBGA and 324MAPBGA Site Expansion : Burn-In from TTM to TTTJ, and Final Test from NXP-ATKL to NXP-ATTJ

Description

NXP Semiconductors announces the Burn in and Final Test site expansion for the MPC5748G products (0N78S and 1N81M) 256MAPBGA and 324MAPBGA packages associated with this notification

1. Burn-in site expansion from the current Trio Tech Malaysia (TTM), Petaling Jaya, Malaysia Burn-in site to the Trio Tech Tianjin (TTTJ), Tianjin, China Burn-in site.
2. Final Test site expansion from the current NXP-ATKL, Petaling Jaya, Malaysia Final Test site to the NXP-ATTJ, Tianjin, China Final Test site.

Site expansion was successfully qualified adhering to NXP specifications.

Corresponding ZVEI Delta Qualification Matrix ID: SEM-TF-01

Please see the attached file(s) for additional details.

Reason

Site expansion qualification is required for manufacturing flexibility and customer supply assurance.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Disposition of Old Products

Existing inventory will be shipped until depleted

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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NXP Semiconductors

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Affected Part Numbers

SPC5748GK1MMJ6

SPC5748GGK1MMJ6

SPC5748GK1MMN6